TECHNICAL DATA DATA SHEET 4031, Rev. A

## SILICON SCHOTTKY RECTIFIER DIE Very Low Forward Voltage Drop (150 °C T<sub>J</sub> Operation)

### **Applications:**

• Switching Power Supply • Converters • Free-Wheeling Diodes • Polarity Protection Diode

#### Features:

- Soft Reverse Recovery at Low and High Temperature
- Very Low Forward Voltage Drop
- Low Power Loss, High Efficiency
- High Surge Capacity
- Guard Ring for Enhanced Durability and Long Term Reliability
- Guaranteed Reverse Avalanche Characteristics
- Electrically / Mechanically Stable during and after Packaging

### **Maximum Ratings**(1):

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	$V_{RWM}$	-	45	V
Max. Average Forward Current	$I_{F(AV)}$	50% duty cycle, rectangular wave form	30	А
Max. Peak One Cycle Non- Repetitive Surge Current	I <sub>FSM</sub>	8.3 ms, half Sine wave	570	А
Non-Repetitive Avalanche Energy	E <sub>AS</sub>	$T_J = 25  ^{\circ}\text{C}, \ I_{AS} = 1.1  A, \\ L = 60  \text{mH}$	36	mJ
Repetitive Avalanche Current	I <sub>AR</sub>	$I_{AS}$ decay linearly to 0 in 1 $\mu$ s $f$ limited by $T_J$ max $V_A$ =1.5 $V_R$	6.0	А
Max. Junction Temperature	$T_J$	-	-65 to +150	°C
Max. Storage Temperature	$T_{stg}$	-	-65 to +150	°C

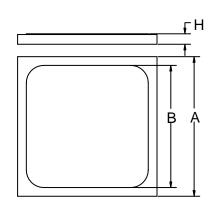
#### **Electrical Characteristics**(1):

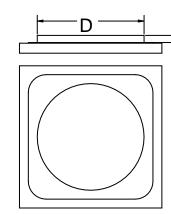
Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop	$V_{F1}$	@ 30A, Pulse, T <sub>J</sub> = 25 °C	0.56	V
	$V_{F2}$	@ 30A, Pulse, T <sub>J</sub> = 125 °C	0.51	V
Max. Reverse Current	ax. Reverse Current I <sub>R1</sub>		3.0	mA
		T <sub>J</sub> = 25 °C		
	$I_{R2}$	@V <sub>R</sub> = 45V, Pulse,	140	mA
		T <sub>J</sub> = 125 °C		
Max. Junction Capacitance	Ст	$@V_R = 5V, T_C = 25  ^{\circ}C$	1600	pF
		$f_{SIG} = 1MHz,$		
		$V_{SIG} = 50 \text{mV (p-p)}$		

(1) in SHD package

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#### Mechanical Dimensions: In Inches / mm





Bottom side metalization Ag - 30 kÅ minimum.

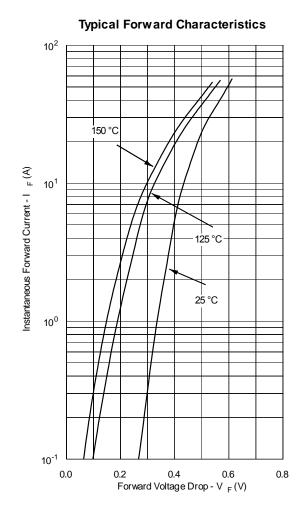
Top side metalization

A = AI - 25 kÅ minimum

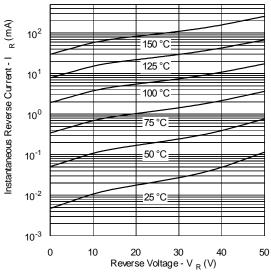
B = Ag -30 kÅ minimum C= Au plated Ni-Moly disc with bare edge

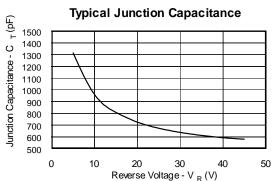
Bottom side is cathode, top side is anode.

A	В	D	Н	h
$0.175 \pm 0.003$	$0.163 \pm 0.003$	$.120 \pm 0.003$	$0.0105 \pm 0.001$ , for Al top	.011± 0.0008
$(4.45 \pm 0.077)$	$(4.14 \pm 0.077)$		$0.0155 \pm 0.001$ , for Ag top	



# Typical Reverse Characteristics







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